

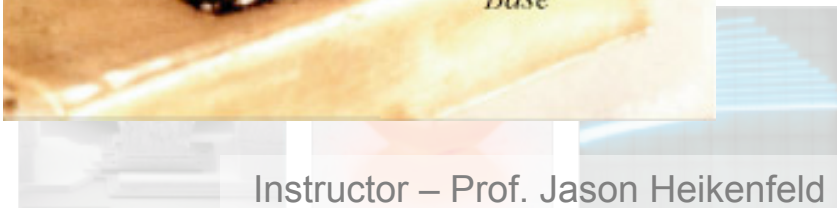
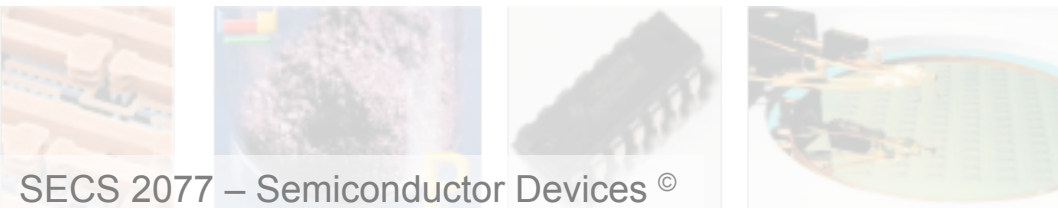
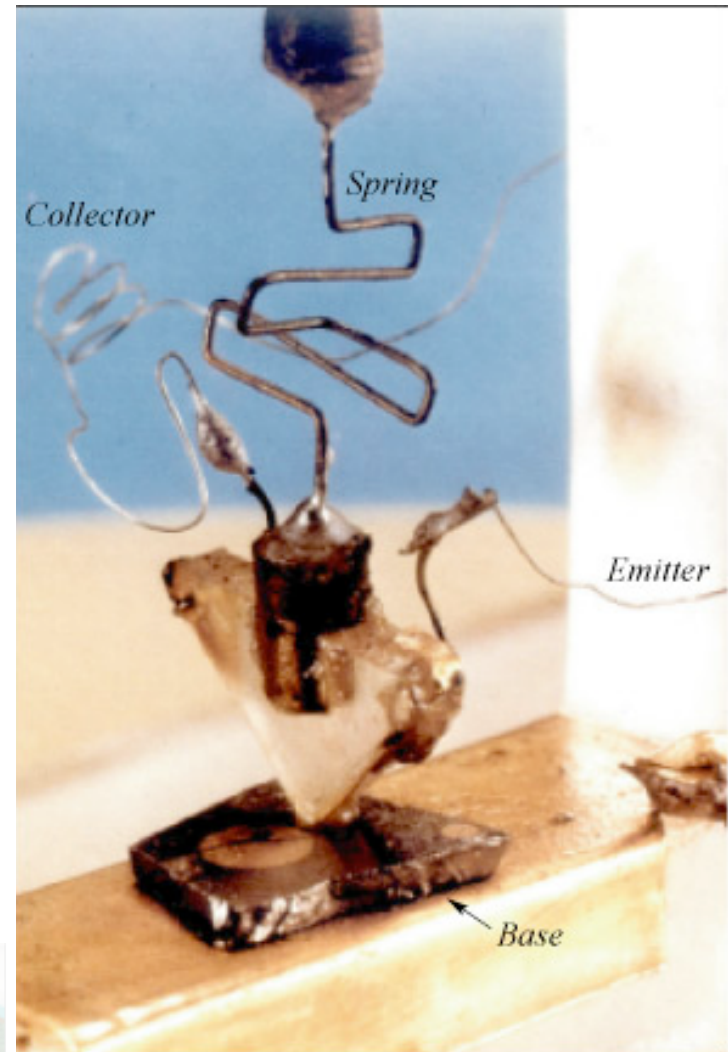
# 7.1, 7.2 – BJT Fundamentals

## 7.6 - BJT Switching

*The first transistor (point contact) was invented at Bell Laboratories on December 16, 1947 by William Shockley, John Bardeen, and Walter Brattain.*

Note:

★ = potential quiz question



## COVER SHEET FOR TECHNICAL MEMORANDA

**SUBJECT:** Terminology for Semiconductor Triodes - Committee  
Recommendations - Case 38139-8

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MM-48-130-10  
DATE May 28, 1948  
AUTHOR L. A. Neacham  
C. O. Mallinckrodt  
H. L. Barney

Surface States -  
Terminology

**ABSTRACT**

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- 23 - M. E. Mohr
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**ABSTRACT**

Recommendations are made for an equivalent circuit representation, and terminology relating to semiconductor triodes.



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ABSTRACT

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Recommendations are made for circuit representation, and terminology for semiconductor triodes.

MM-48-130-10  
DATE: 10-20-1948

Designate by the numbers 1, 2 and 3, the order of your preference for the names listed below:

- \_\_\_\_\_ Semiconductor Triode
- \_\_\_\_\_ Surface States Triode
- \_\_\_\_\_ Crystal Triode
- \_\_\_\_\_ Solid Triode
- \_\_\_\_\_ Iotatron
- \_\_\_\_\_ Transistor
- \_\_\_\_\_ (Other suggestion)

Comments: \_\_\_\_\_

Signed \_\_\_\_\_

Please return this ballot to Miss G. R. Callender in 1A-323 at Murray Hill.



▶ This is a PNP BJT...



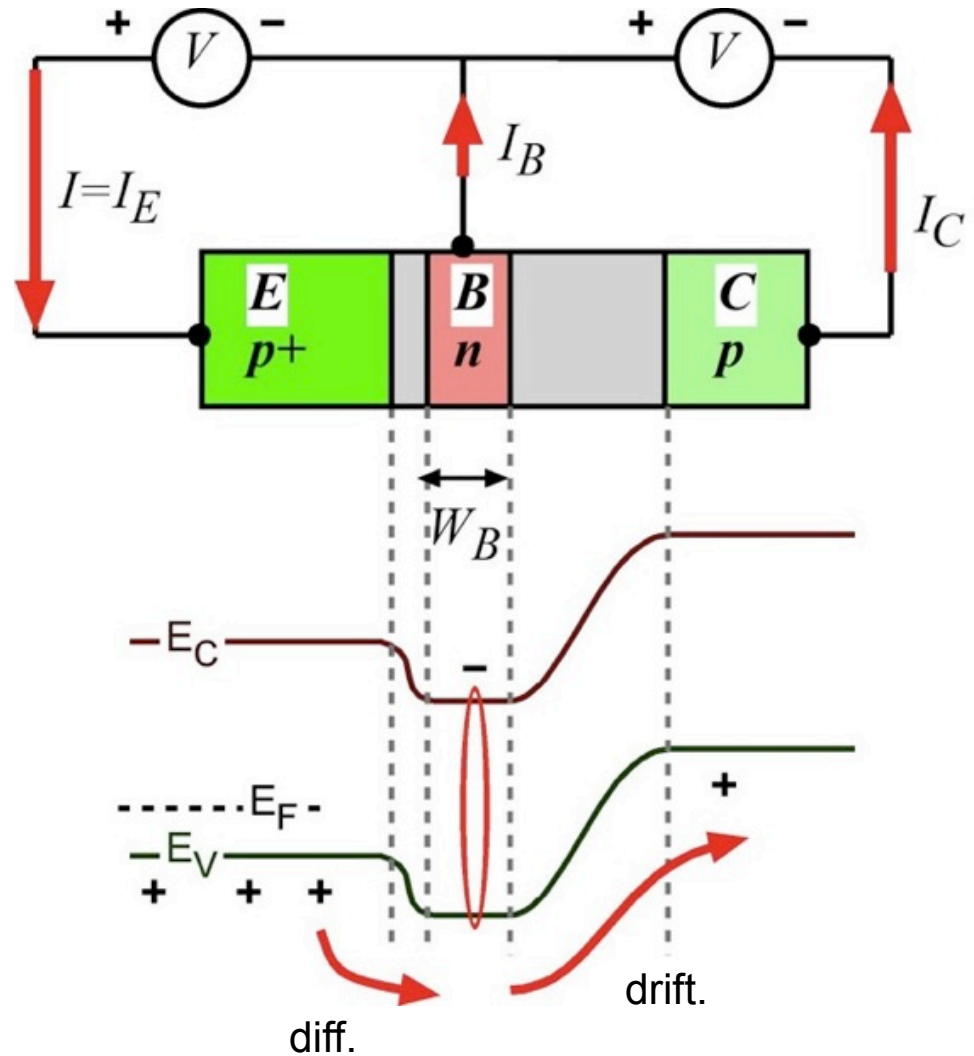
... it is two diodes, one reverse biased, one forward biased... So we need to review diodes first!

**E**mitter  
**B**ase  
**C**ollector  
 $I = I_E = I_B + I_C$

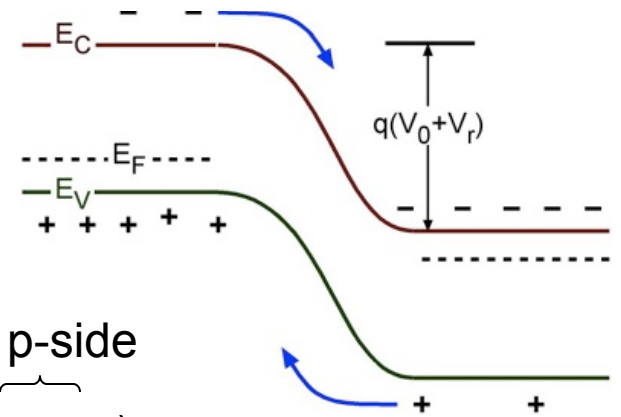
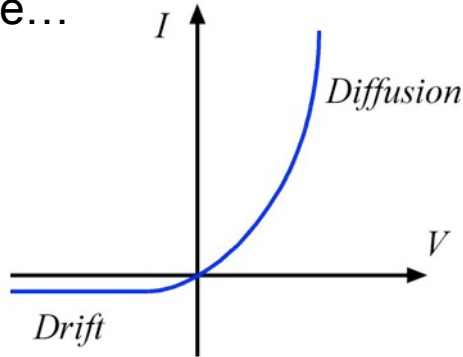
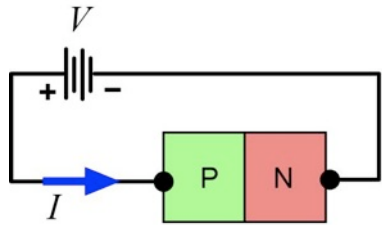
▶ Lets first look at the reverse biased diode, the COLLECTOR (C).

▶ Then look at the forward biased diode, the EMITTER (E).

▶ The, lastly, try to figure out what the BASE (B) does!



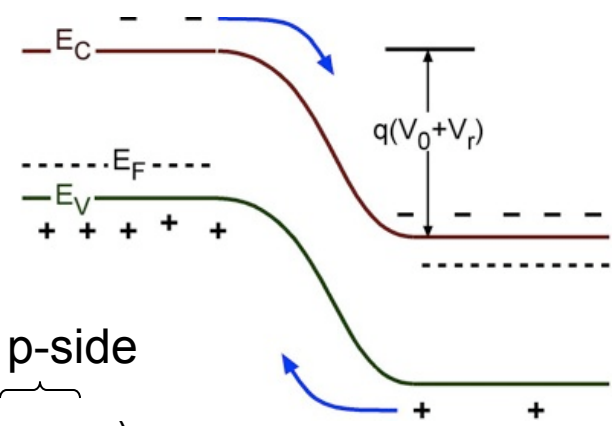
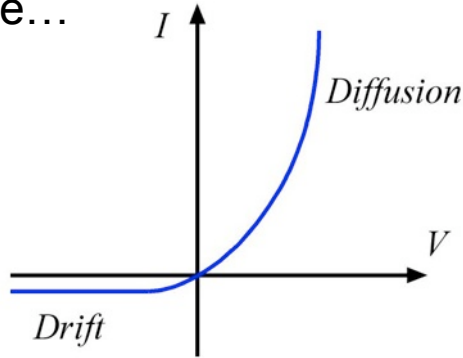
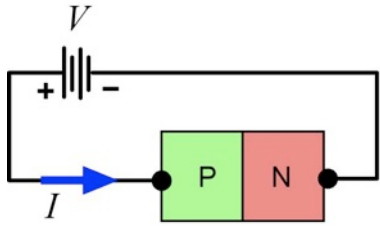
▶ Reverse biased diode...



$$I = I_0(e^{qV/kT} - 1)$$

$$I_0 = qA \left( \frac{D_p}{L_p} p_n - \frac{D_n}{L_n} n_p \right)$$

▶ Reverse biased diode...



$$I = I_0(e^{qV/kT} - 1)$$

$$I_0 = qA \left( \frac{D_p}{L_p} p_n - \frac{D_n}{L_n} n_p \right)$$

▶ The COLLECTOR of a BJT is a reversed biased diode *that collects minority carriers brought to it...*

▶ That is where the EMITTER comes into play... it EMITS carriers that can be COLLECTED by the COLLECTOR.

... but how do we bring those minority carriers in a BJT?

▶ The EMITTER is a special forward biased p+n diode, let's review it now...



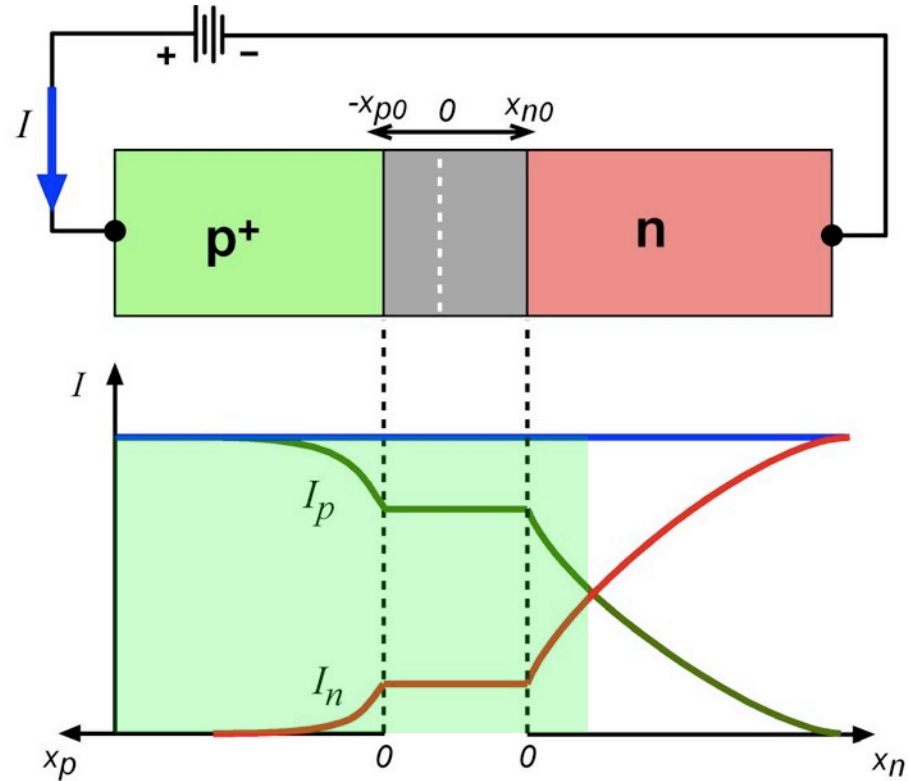
▶ Forward bias:  $I_{diff}$

▶ p+ side has more carriers ready to diffuse so hole current dominates **across and near the junction...**

▶ Deeper in the n-side electron current dominates only because we need to bring in electrons to recombine with all the holes that are we are diffusing over...

▶ KEY POINT: p+n... hole current dominates across junction... and importantly **dominates over a certain distance into the n-type material!**

Okay, now we are ready to make and understand a p+np BJT!



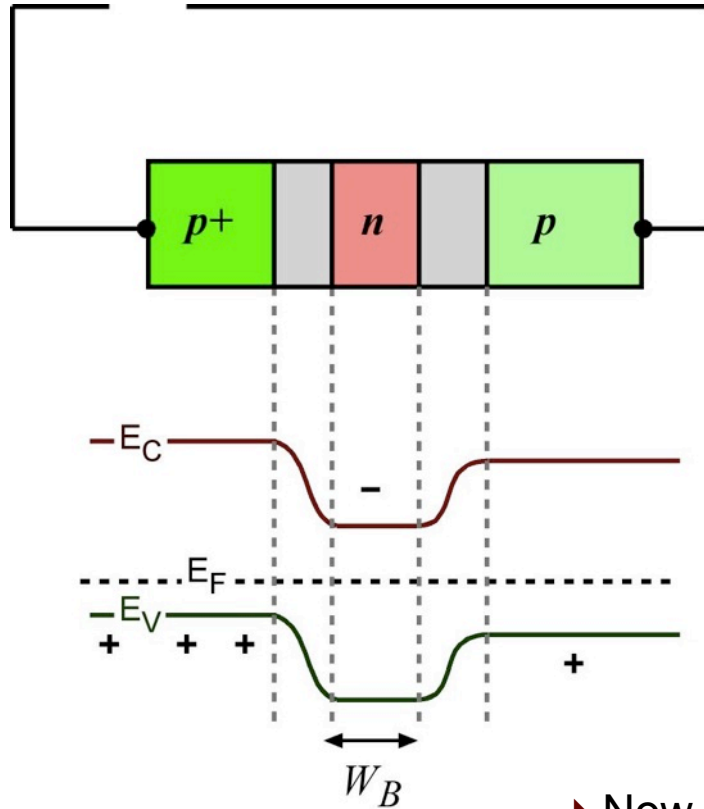
$$I = I_0 (e^{qV/kT} - 1) \quad I_0 = qA \left( \frac{D_p}{L_p} p_n - \frac{D_n}{L_n} n_p \right)$$

$n_p \ll p_n$

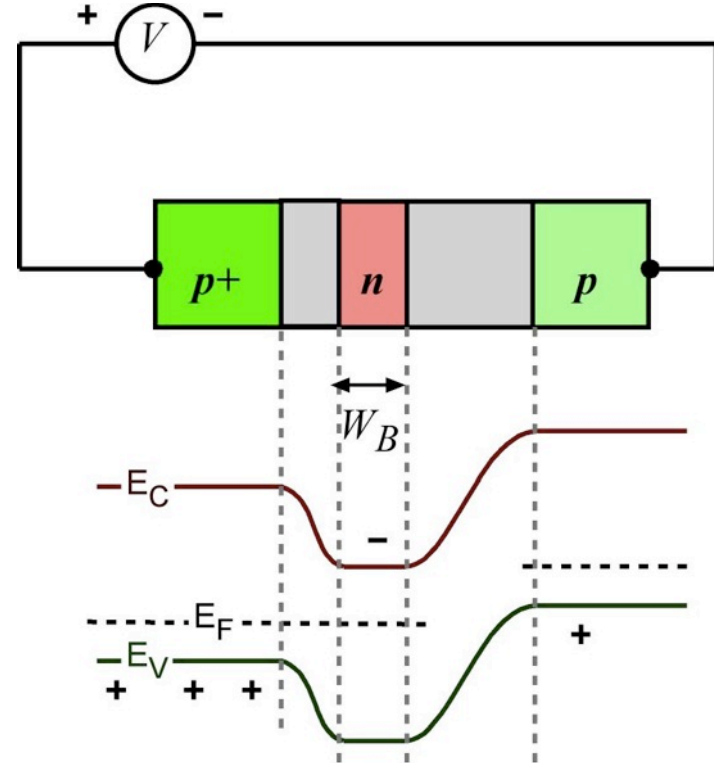


▶ Join p+, n, p Si

▶ Let's keep the n thin ( $W_B$ )

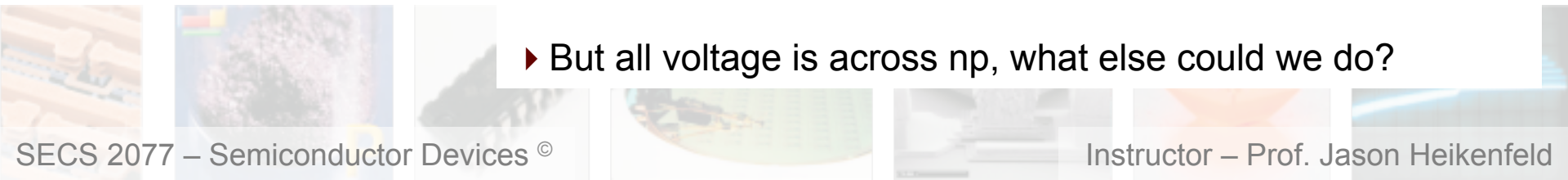


▶ Apply voltage, what happens?  
where is the voltage drop? ☆



▶ Now, if we could inject some more holes from p+ to n, what could happen???

▶ But all voltage is across np, what else could we do?



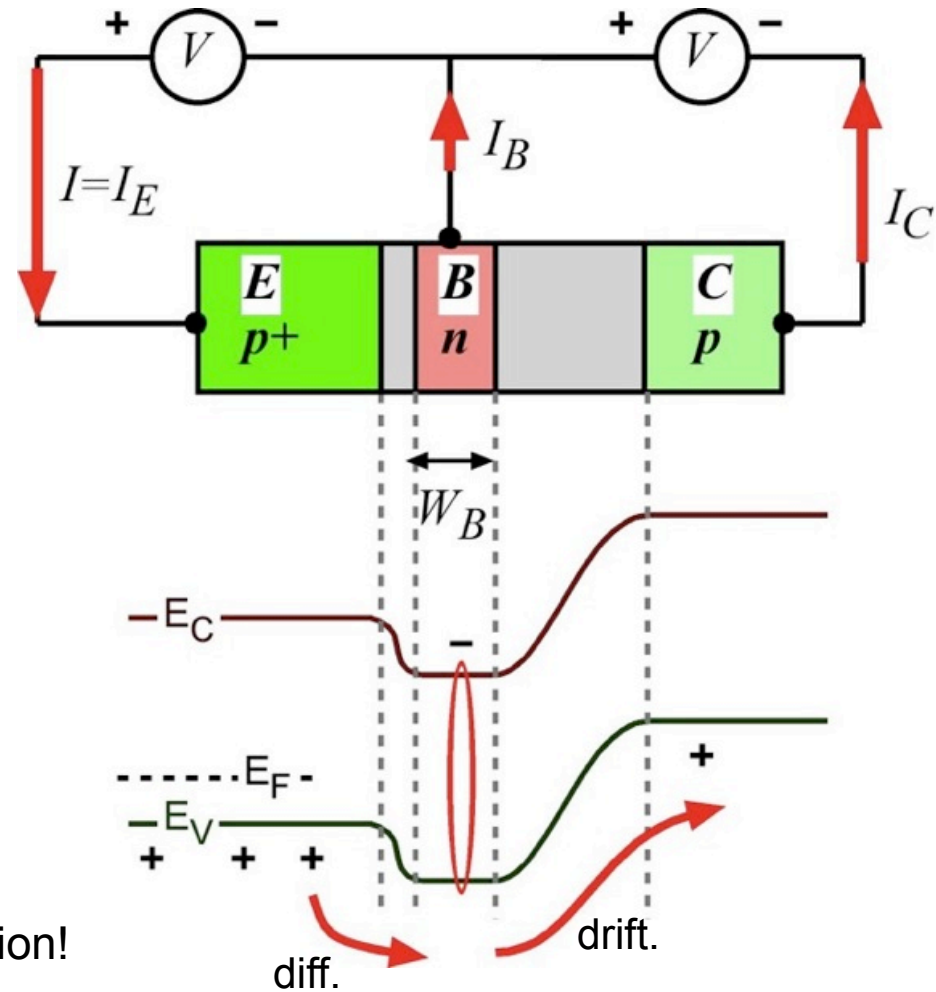


▶ We add a 2nd voltage source to forward bias the p+n junction

- the EB diffusion barrier decreases, current magnitudes for h's vs. e's?

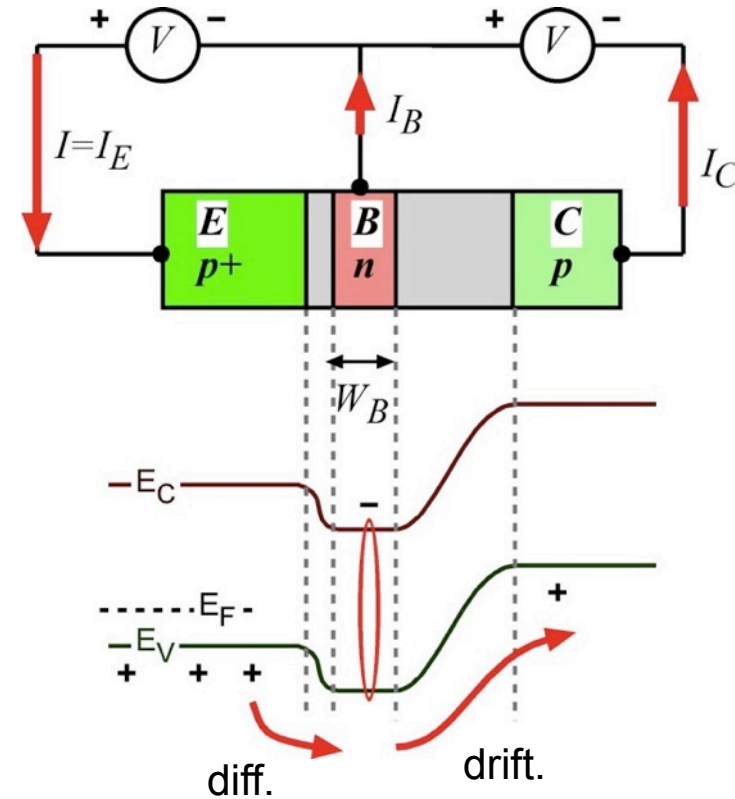
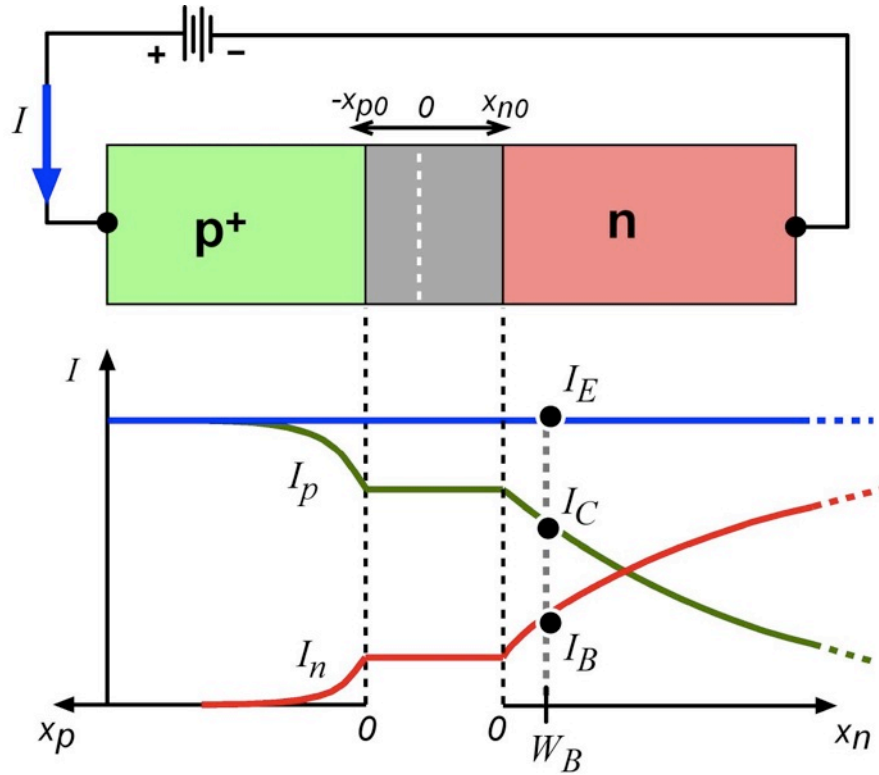
-  $W_B$  is small, so will h's recombine or end up where instead?

- if  $W_B$  was large, how would this change the current due to e's ( $I_B$ )?



▶ Note the magnitudes of currents, amplification!

▶ ☆ Key! At EB side of n we get an excess of holes (forward biased diode), and the BC side of n is a reverse biased diode so what is the hole concentration at that depletion edge? Therefore what drives the holes across the base?



▶ Again, recall we have a **p+n** junction with low  $N_D$  for long  $L_p$ , so that excess of holes is preserved over a distance:  
*example:  $N_D=10^{15}/cc, L_p \sim 100 \mu m$*

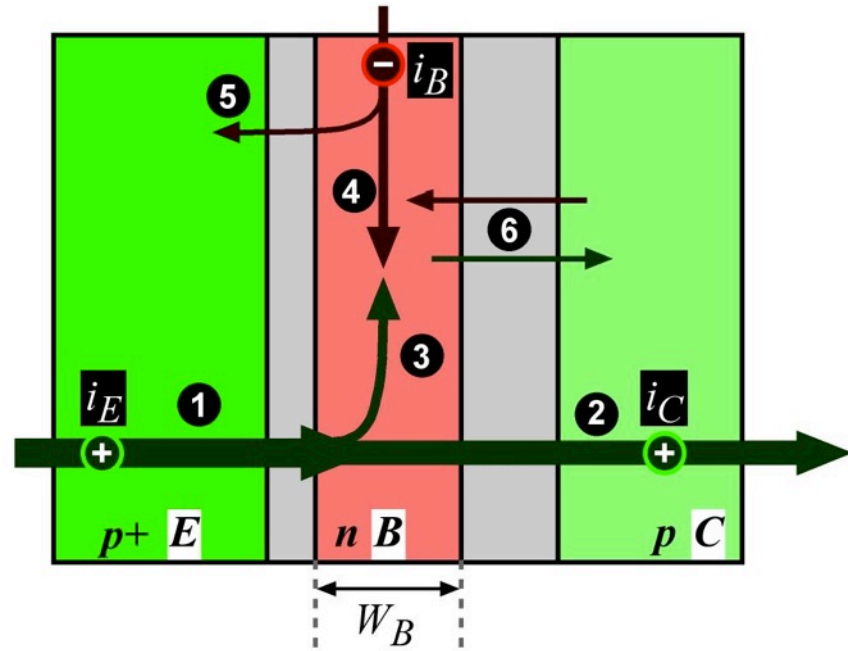
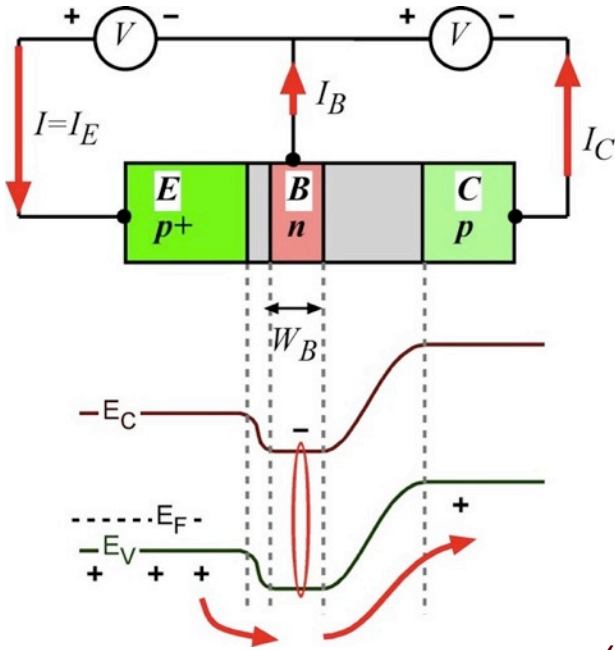
▶ Therefore, the shorter  $W_b$  gets, the smaller  $I_B$  gets... for typical  $W_b$  a very small change in  $I_B$  causes a large change in  $I_C, I_B$  ... typically  $W_b \sim 1 \mu m$ !

$$L_p = \sqrt{D_p \tau_p}$$

$$D_p = \frac{kT}{q} \mu_p \quad \tau_p = \frac{1}{\alpha_r (n_0 + p_0)}$$

*lets look at it another way...*





**E**mitter (inject holes)  
**B**ase (historical, Ge slab)  
**C**ollector (collect holes)  
 $I = I_E = I_B + I_C$

- |     |                              |                                   |
|-----|------------------------------|-----------------------------------|
| (1) | Holes injected do what?      | <b>diffuse</b> across EB          |
| (2) | Holes reach BC and do what?  | <b>drift</b> to C                 |
| (3) | Holes injected do what?      | <b>recombine</b> with B electrons |
| (4) | Electrons injected do what?  | <b>recombine</b> with B holes     |
| (5) | Electrons injected do what?  | <b>diffuse</b> across EB          |
| (6) | Reverse bias e or h do what? | <b>drift</b> across BC (small)    |

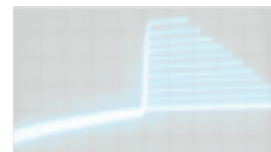
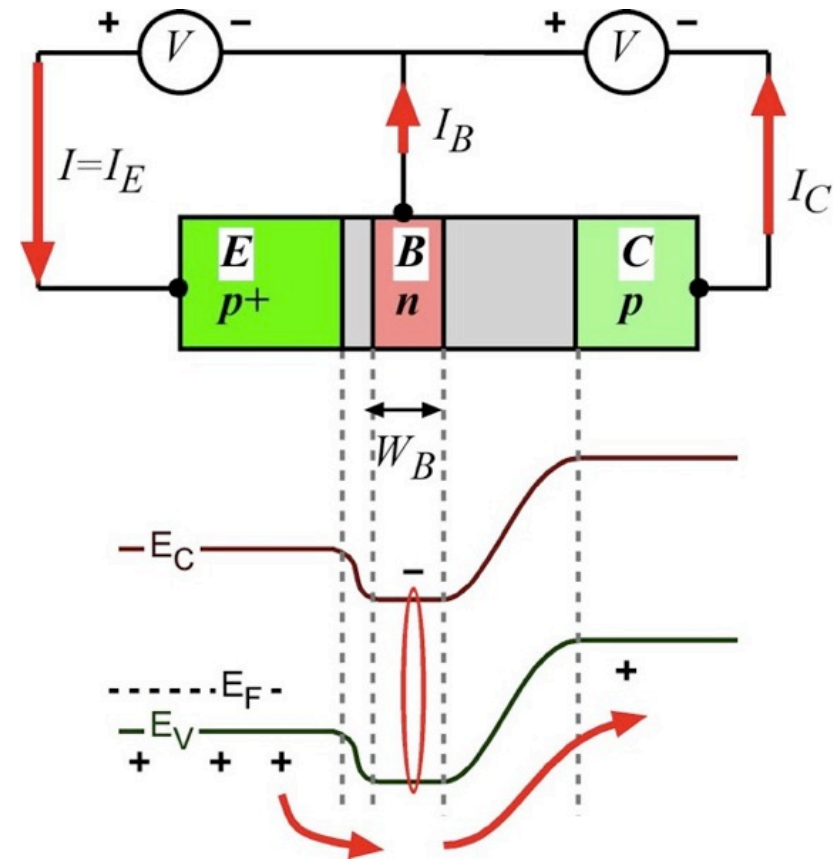
★ Remember:

$p+n$  for EB so (1)  $\gg$  (5),  $W_b \ll L_p$  so (2)  $\gg$  (3), but (3)  $\neq 0$



► Make sure you are solid on the starred items (★), and if you paid attention, you should be able to answer these questions:

- (1) The emitter 'emits' by being Forward or reverse biased? Drift or diffusion?
- (2) The collector 'collects' by being Forward or reverse biased? Drift or diffusion?
- (3) We get amplification because the a small base current results in large emitter and collector currents. The base current is small and we get strong current amplification because of what? See slide 11.



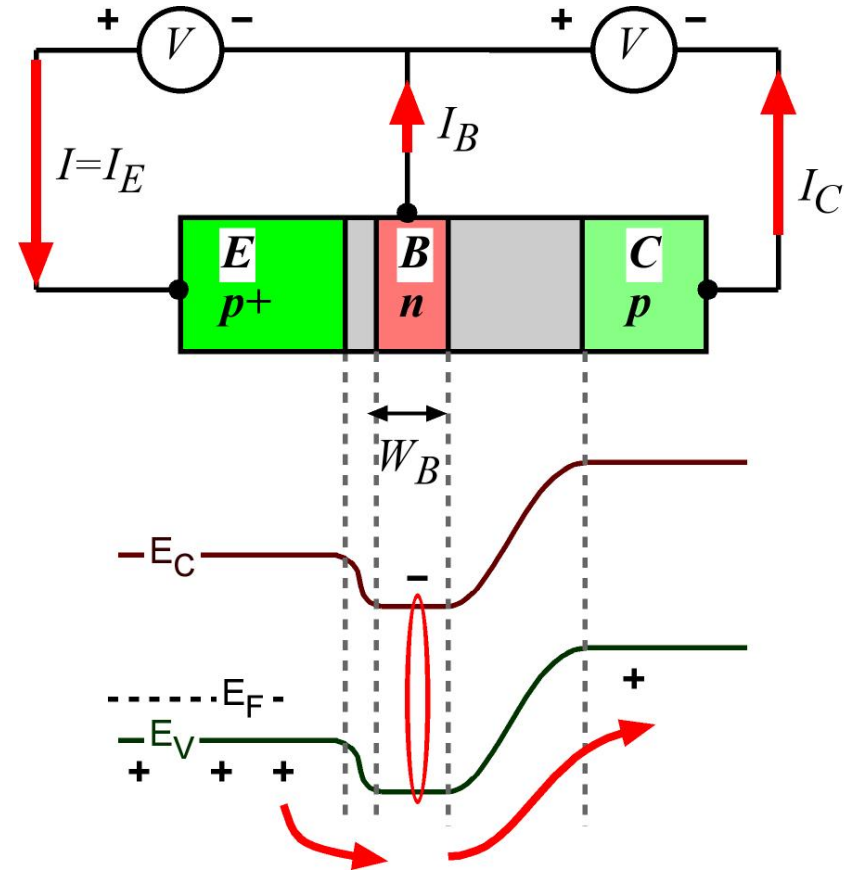
► Quick note to start... we figured out the model for pnp BJT, what about npn?

*all currents reversed...!*

► BJTs great for **high power** / high frequency amplifiers (small change in  $I_B$  leads to large change in  $I_C$ )

► To understand amplification lets look a idealized (simple) model that assumes:

- (1) No rev. saturation current in  $I_C$
- (2) DC & low frequency AC
- (3) Neglect recombination in depletion regions (but not in base!)



► First note current directions (e,h movement vs. current)

► Next, relate  $i_{Ep}$  (not  $i_E$ ) to  $i_C$  using a proportionality constant B

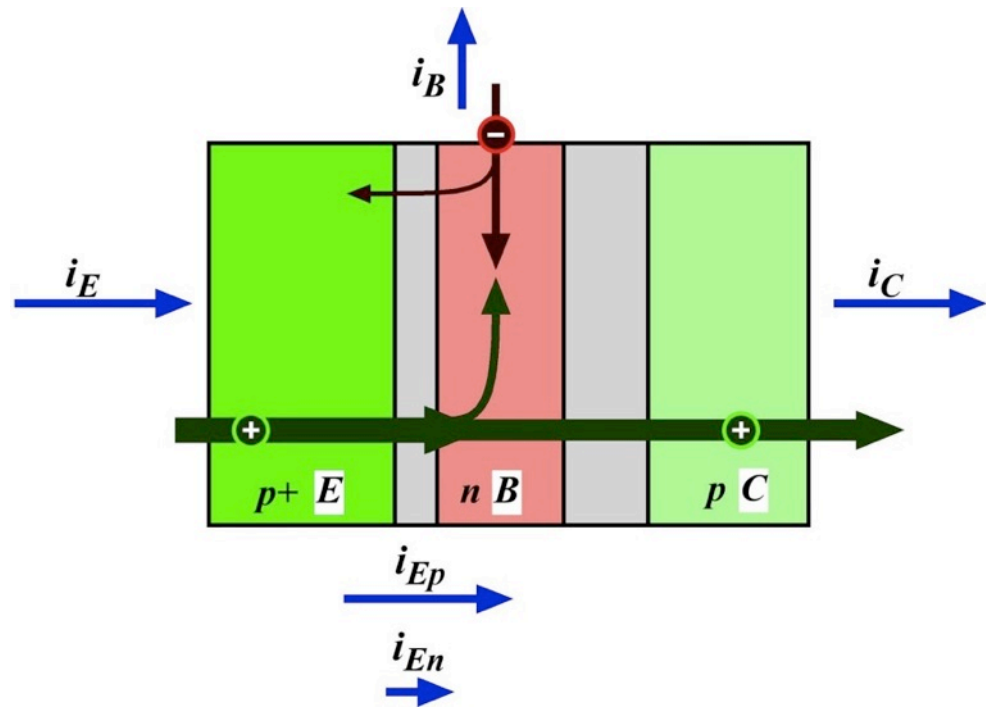
$$i_c = Bi_{Ep}$$

$B = \text{base transport factor}$

► Ideally want h injection (diffusion) **not e** across EB (small  $i_{En}$ , large  $i_{Ep}$ ):

$$i_E = i_{En} + i_{Ep} \quad \gamma = \frac{i_{Ep}}{i_{En} + i_{Ep}}$$

$\gamma = \text{emitter injection efficiency}$



► We can further define current transfer ratio ( $\alpha$ ) as:

$$\alpha = \frac{i_C}{i_E} = \frac{Bi_{Ep}}{i_{En} + i_{Ep}} = B\gamma$$

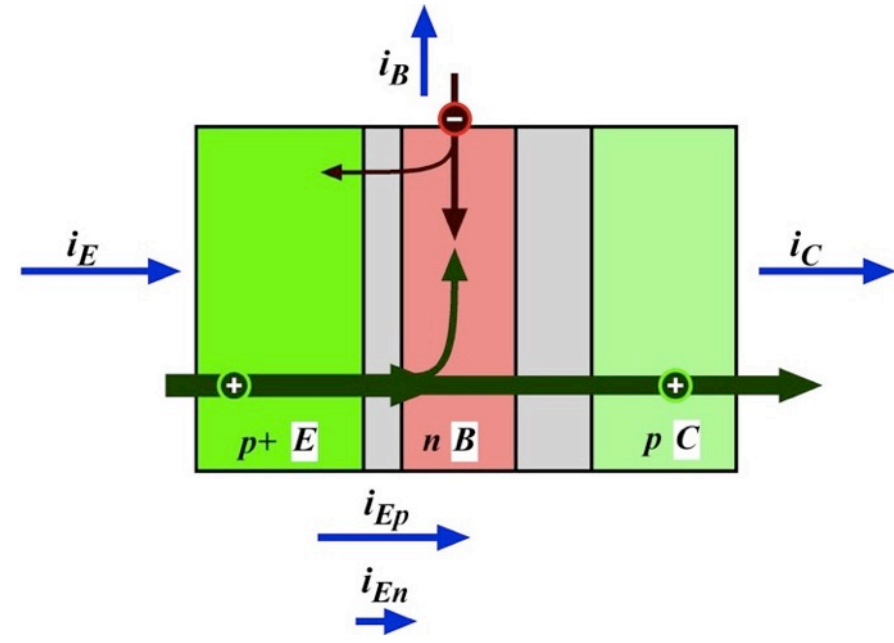
► In an ideal world, what value should we want for B,  $\gamma, \alpha$  ?

Good thing that base is lightly doped, and  $p+n!$  and  $W_b$  is thin!



► We would like our *current transfer ratio* ( $\alpha$ ) to be close to unity... but this says nothing about gain

$$i_c = B i_{Ep} \quad \gamma = \frac{i_{Ep}}{i_{En} + i_{Ep}} \quad \alpha = \frac{i_c}{i_E} = \frac{B i_{Ep}}{i_{En} + i_{Ep}} = B \gamma$$



► Let's turn our attention to  $i_B$ ...

$$i_B = \underbrace{i_{En}}_{\text{e's diff. across EB junction}} + \underbrace{(1 - B) i_{Ep}}_{\text{e's needed to recombine with some of the holes injected from EB (holes that do not make it across base)}}$$

e' s diff. across EB junction      e' s needed to recombine with some of the holes injected from EB (*holes that do not make it across base*)

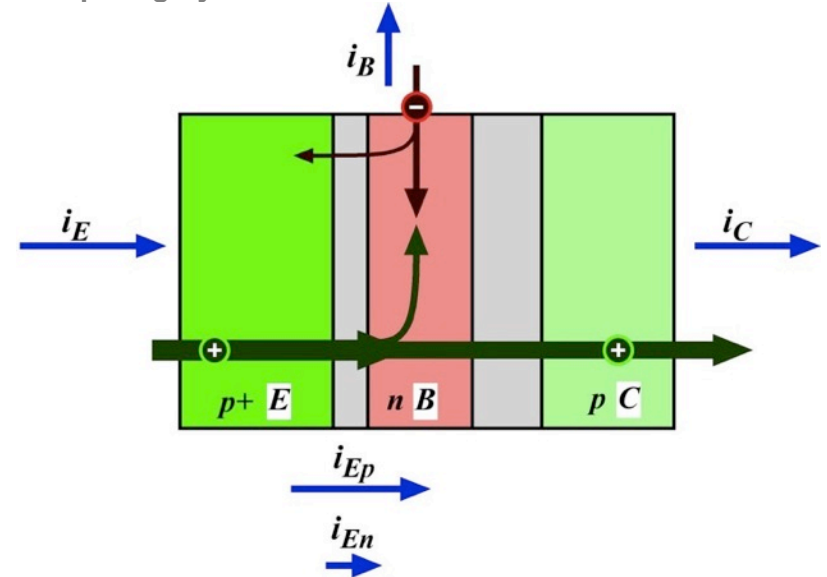
► *right away we notice that neither of these components helps us increase  $i_c$ , so ideally we want these components to be?*



► What we know so far

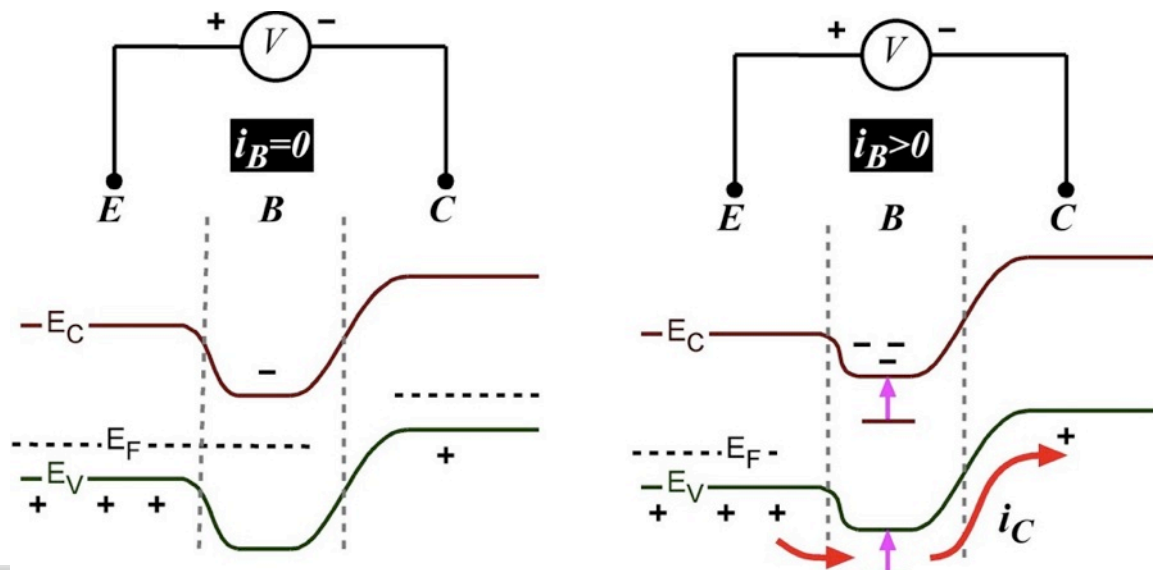
$$i_c = \beta i_{Ep} \quad \alpha = \frac{i_c}{i_E} = \frac{\beta i_{Ep}}{i_{En} + i_{Ep}} = \beta \gamma$$

$$\gamma = \frac{i_{Ep}}{i_{En} + i_{Ep}} \quad i_B = i_{En} + (1 - \beta) i_{Ep}$$



► So for maximum amplification, we desire a large change in  $i_c$  to a small change in  $i_B$ ....

How can we calculate this?





► What we know so far

$$i_c = B i_{Ep} \quad \alpha = \frac{i_C}{i_E} = \frac{B i_{Ep}}{i_{En} + i_{Ep}} = B \gamma$$

$$\gamma = \frac{i_{Ep}}{i_{En} + i_{Ep}} \quad i_B = i_{En} + (1 - B) i_{Ep}$$

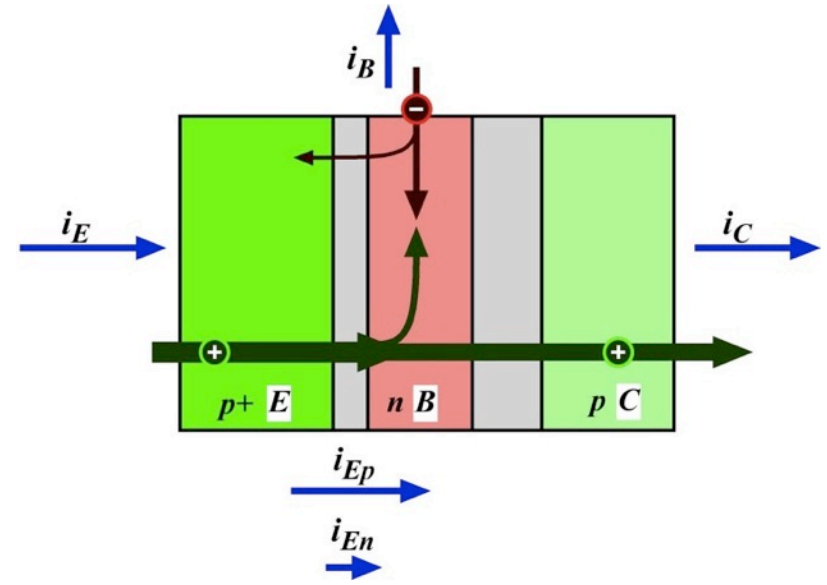
► We can express our base-to-collector amplification factor ( $\beta$ ) as:

$$\frac{i_C}{i_B} = \frac{B i_{Ep}}{i_{En} + (1 - B) i_{Ep}}$$

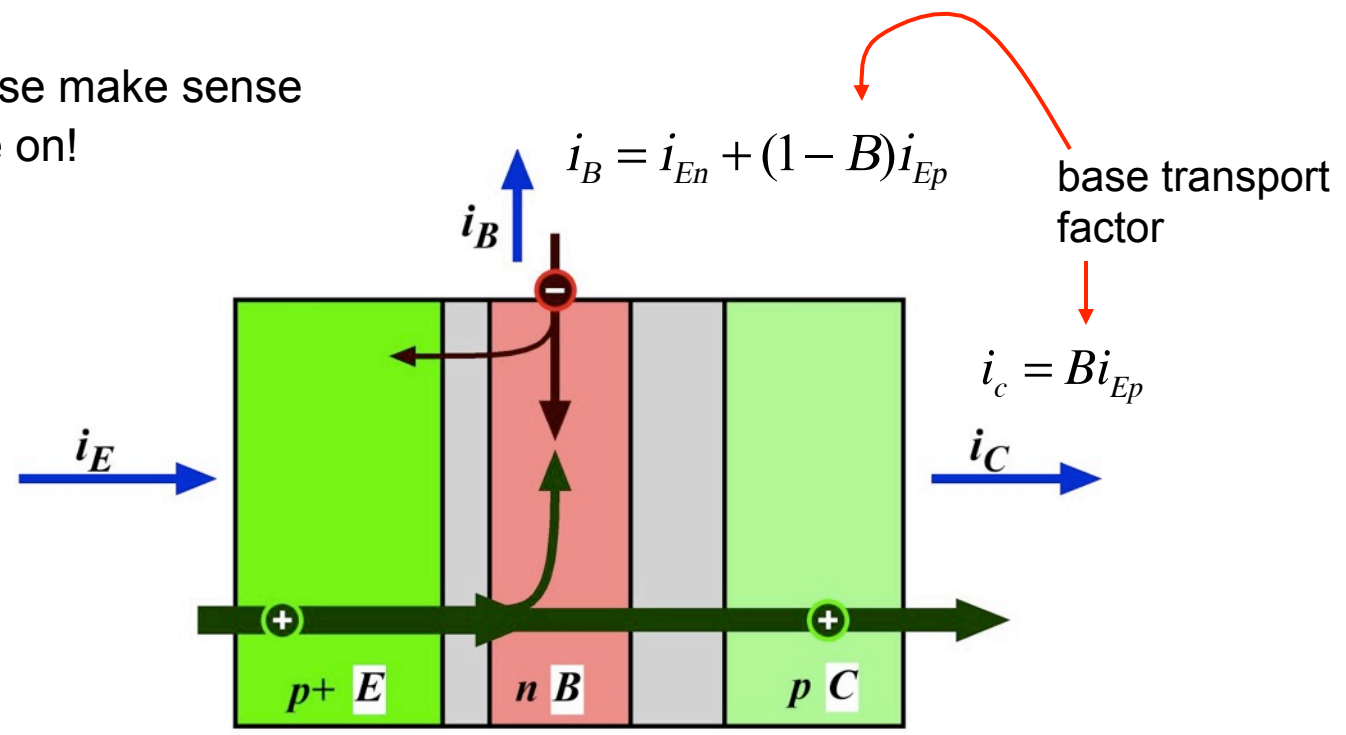
$$= \frac{B [i_{Ep} / (i_{En} + i_{Ep})]}{i_{En} / (i_{En} + i_{Ep}) + (1 - B) [i_{Ep} / (i_{En} + i_{Ep})]} = \frac{B [i_{Ep} / (i_{En} + i_{Ep})]}{\underbrace{i_{En} / (i_{En} + i_{Ep}) + i_{Ep} / (i_{En} + i_{Ep})}_{1} - B [i_{Ep} / (i_{En} + i_{Ep})]}$$

$$\frac{i_C}{i_B} = \frac{B \gamma}{1 - B \gamma} = \frac{\alpha}{1 - \alpha} \equiv \beta$$

$\alpha$  can be close to unity in real devices so  $\beta$  can be very large

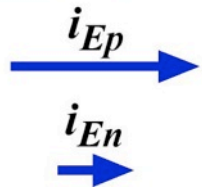


► Make sure these make sense before you move on!



emitter injection efficiency

$$\gamma = \frac{i_{Ep}}{i_{En} + i_{Ep}}$$

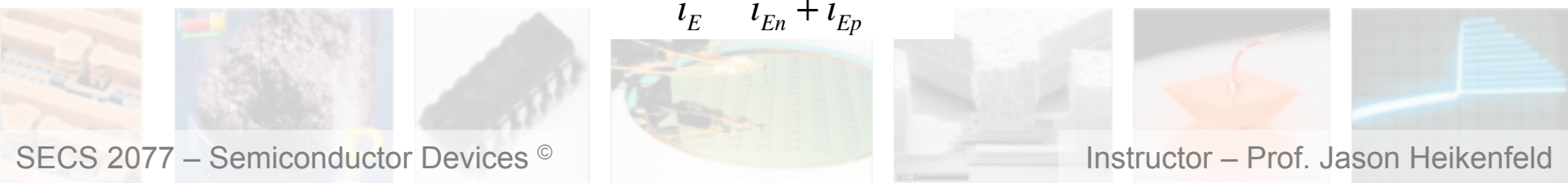


amplification factor

$$\frac{i_C}{i_B} = \frac{B\gamma}{1 - B\gamma} = \frac{\alpha}{1 - \alpha} \equiv \beta$$

current transfer ratio

$$\alpha = \frac{i_C}{i_E} = \frac{Bi_{Ep}}{i_{En} + i_{Ep}} = B\gamma$$



▶ Let look at amplification another way as well... assume unity injector efficiency (all injected e' s stay in base)

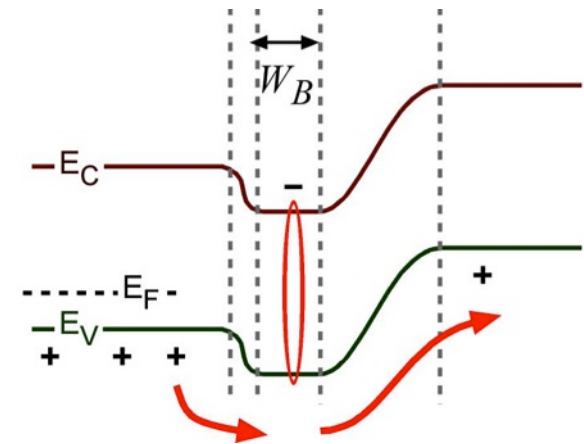
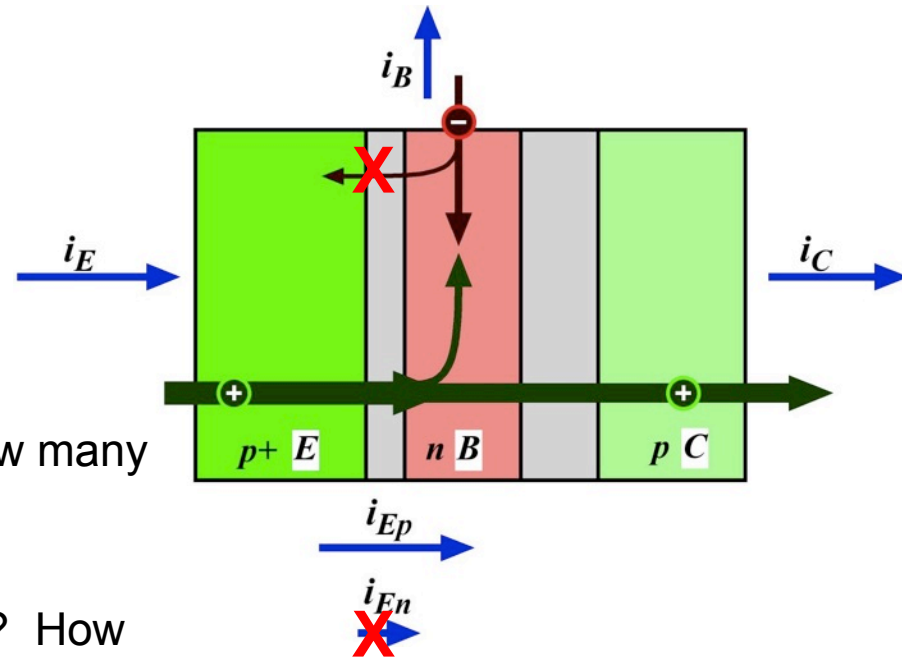
▶ We know we always must have charge neutrality in the base.

▶ So, if we add 5 extra electrons to the base, how many extra holes will be in the base at any given time?

▶ The electrons we added, do they just sit there? How do they sit there, and how long until, they disappear?

▶ During the time it takes for the electrons to disappear what were the holes doing? Relatively, how long does a hole spend in the base, longer or shorter than time for an electron?

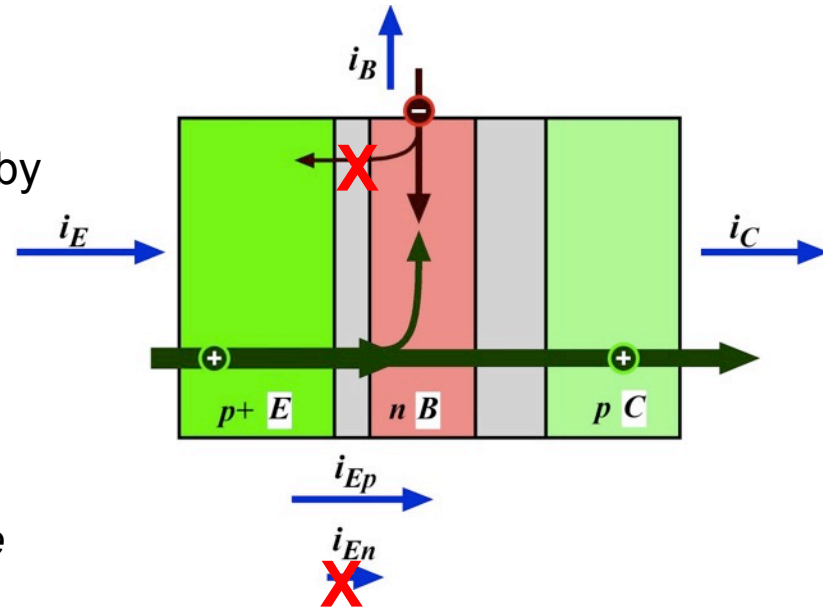
▶ How can we use this to calculate amplification factor?



▶ Thus, for each e entering the base through the base contact,  $t_p/t_t$  h's can pass through the base region with out upsetting the balance maintained by charge neutrality. ( $t_t$  is the h transit time)

▶ This implies that:

$$\frac{i_C}{i_B} = \beta = \frac{\tau_p}{\tau_t} \quad \text{another reason why we want a thin base!}$$



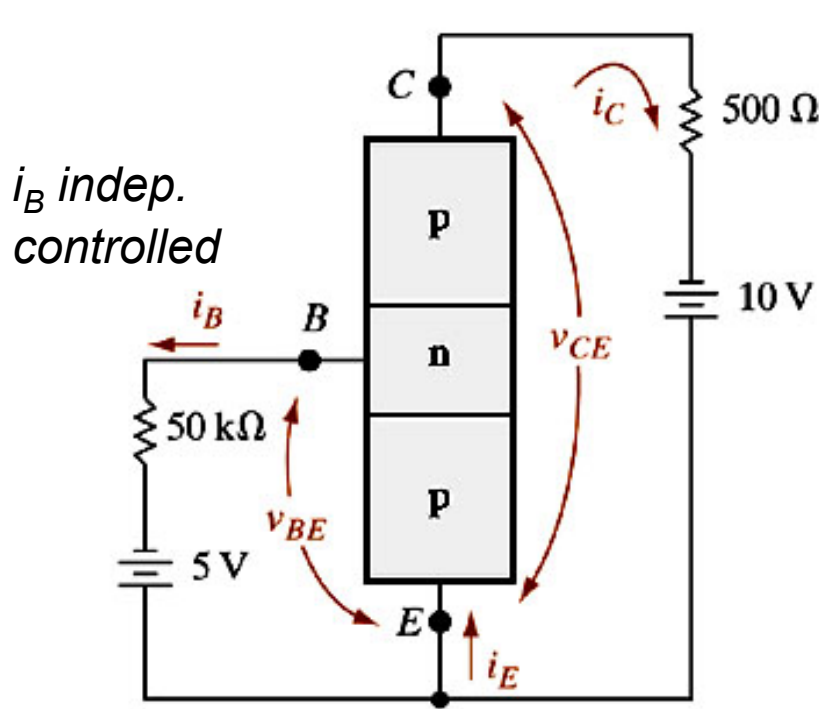
▶ What happens if we restrict or increase the flow of e's coming from the base contact?

- (1) We must maintain charge neutrality (same # of e's and h's in base). ☆
- (2) Any change in e's in the base requires a much larger change in h's flowing through the base since most h's go through without recombining... *amplification*.



► An example circuit:

‘common emitter’ where emitter is common (ground) to B and C



$i_B$  indep. controlled

note  $I_C$  indep. of load!

$$\tau_p = 10 \mu s$$

$$\tau_t = 0.1 \mu s$$

$$\frac{i_C}{i_B} = \beta = \frac{\tau_p}{\tau_t} = 100$$

Neglecting  $v_{BE}$

$$I_B = \frac{5 V}{50 k\Omega} = 0.1 \text{ mA}$$

$$I_C = \beta I_B = 10 \text{ mA}$$

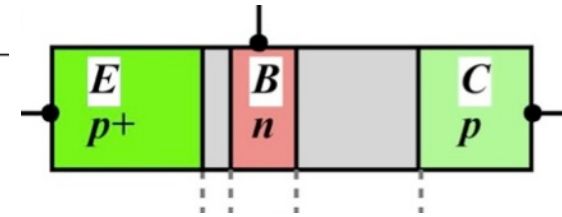


**TOSHIBA**

TOSHIBA Transistor Silicon PNP Epitaxial Type (PCT process)

**2SA1163**

Audio Frequency General Purpose Amplifier Applications



▶ What is the amplification factor (two ways to get it)... ☆

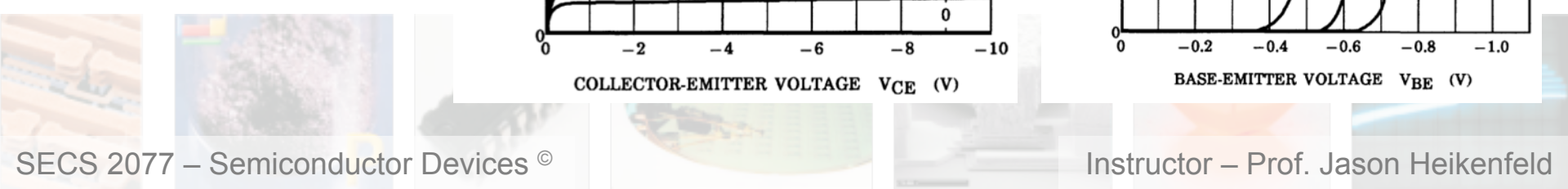
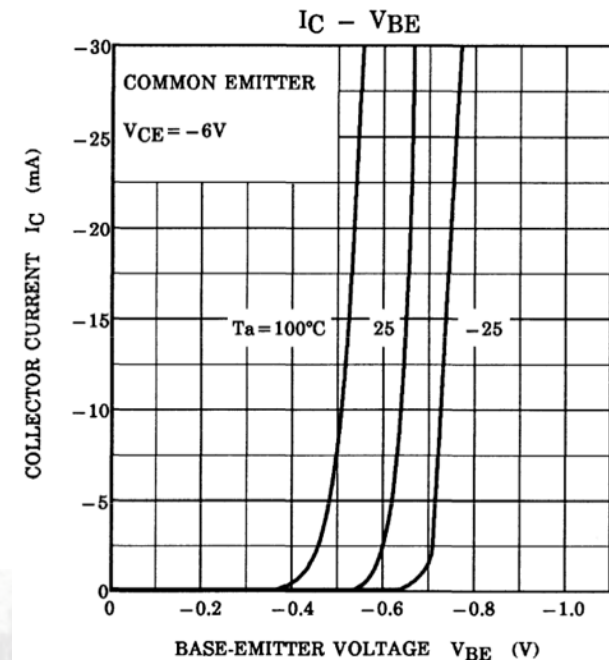
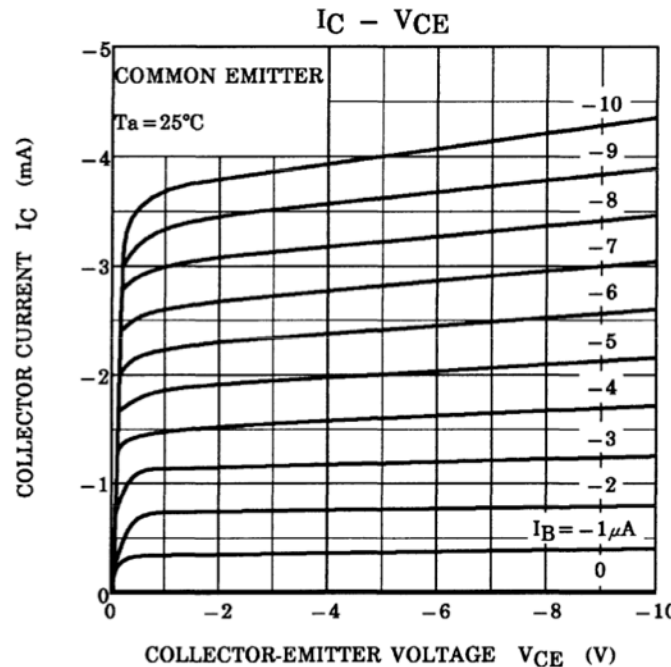
▶ Why is  $I_C$  so beautifully linear to  $I_B$ ? ☆

▶ What does  $I_C$  vs.  $V_{BE}$  look like, and why? ☆

▶ Why does  $I_C$  saturate with increasing  $V_{CE}$ ?  
Hmm... lets look at the final part for this lecture...

▶ Why does  $I_C$  saturation have a slope to it? Wait till next lectures...

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Collector cut-off current	$I_{CBO}$	$V_{CB} = -120\text{ V}, I_E = 0$	—	—	-0.1	$\mu\text{A}$
Emitter cut-off current	$I_{EBO}$	$V_{EB} = -5\text{ V}, I_C = 0$	—	—	-0.1	$\mu\text{A}$
DC current gain	$h_{FE}$ (Note)	$V_{CE} = -6\text{ V}, I_C = -2\text{ mA}$	200	—	700	
Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_C = -10\text{ mA}, I_B = -1\text{ mA}$	—	—	-0.3	V
Transition frequency	$f_T$	$V_{CE} = -6\text{ V}, I_C = -1\text{ mA}$	—	100	—	MHz



▶ Normal forward mode operation with R... R could be internal, contact, or external! A load is always there and often listed as  $R_{out}$


▶ 40V supply is fixed,  $R_{out}=5\text{ k}\Omega$ :  $\therefore I_C \leq \frac{-V_{CE}}{R} \leq 8\text{ mA}$

▶ If  $I_B$  small or negative then how much current flows through the  $R_{out}$ ? Where is the voltage drop then?

- this is referred to as BJT **C**utoff (min current!)

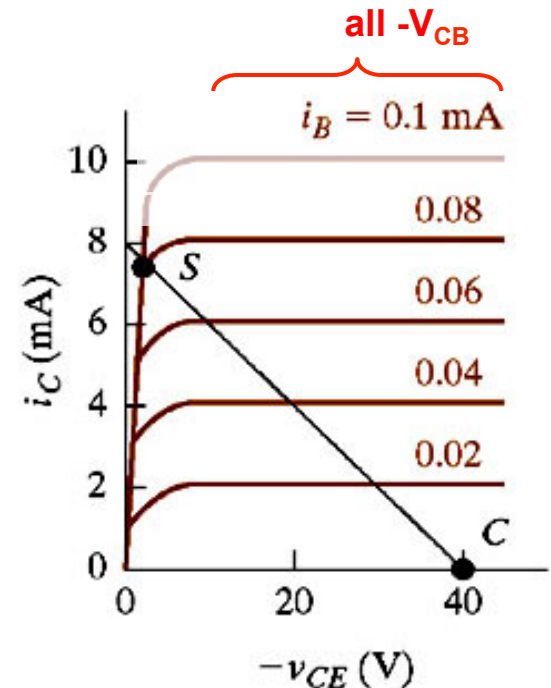
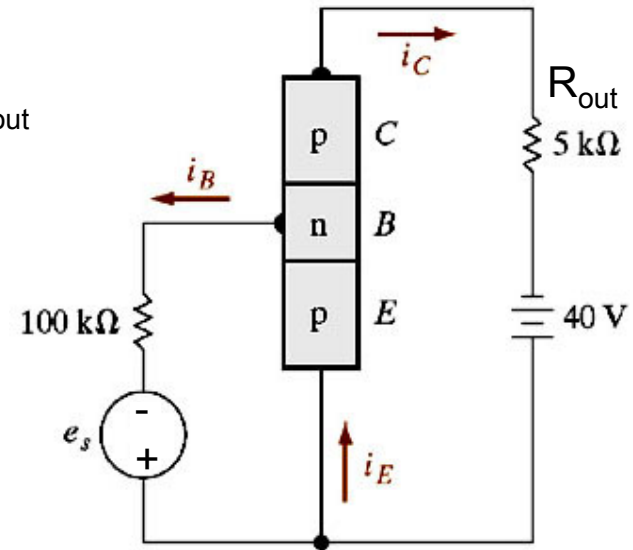
▶ If we increase  $I_B$  by just a bit we get an increase in  $I_C$

- each increase in  $I_B$  shown as new curve (typical for BJT)
- what is our value for  $\beta$  ?

▶ Lets say we keep increasing  $I_B$ , and more current flows  through  $R_{out}$ ... Where is the voltage drop then? So if we keep increasing  $I_B$  will  $I_C$  keep increasing as well?

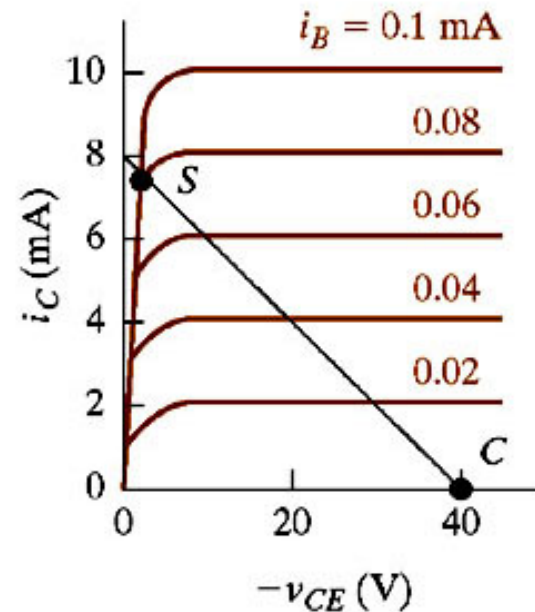
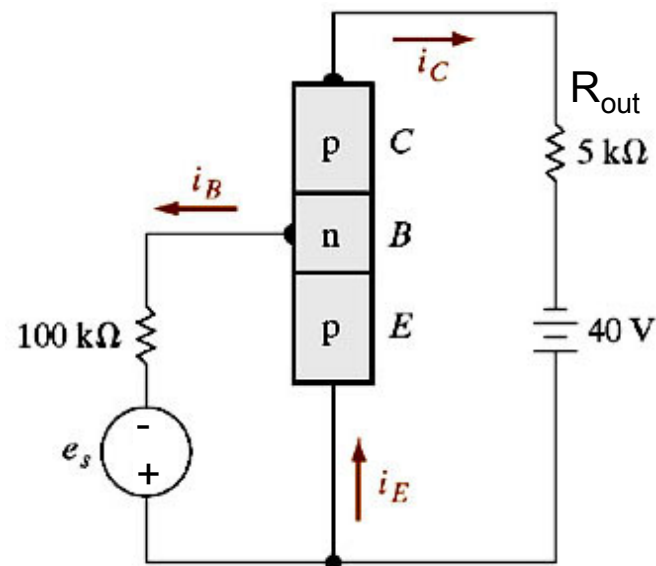
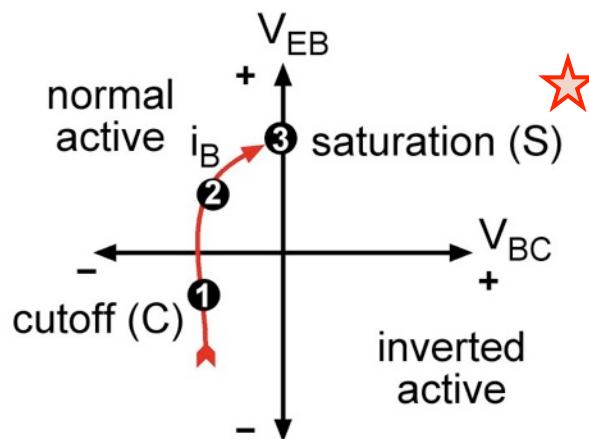
- this is referred to as BJT **S**aturation!
- look at how it nicely follows the load line!

▶ As we increase  $V_{CE}$  the current saturates, why? Hint - where does the applied  $V_{CE}$  appear... does more help at all?



- Four regions of operation:
  - Cutoff: EB at 0V or reverse biased
  - Normal Active: EB forward and BC reverse
  - Saturation: EB strong forward, BC ~ 0V
  - Inverted Active: what is it?

$i_B$ (mA)	$I_C$ (mA)	$V_{CE}$
①, <0	0	40 V
②, >0	...	...
③, >0.08	8	0 V



Ways to use a BJT:

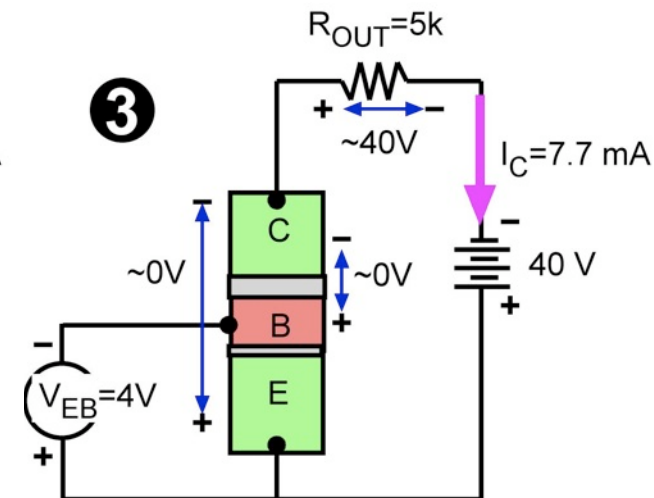
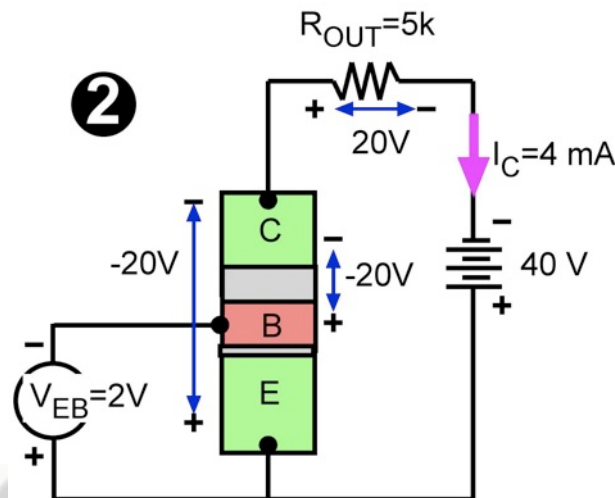
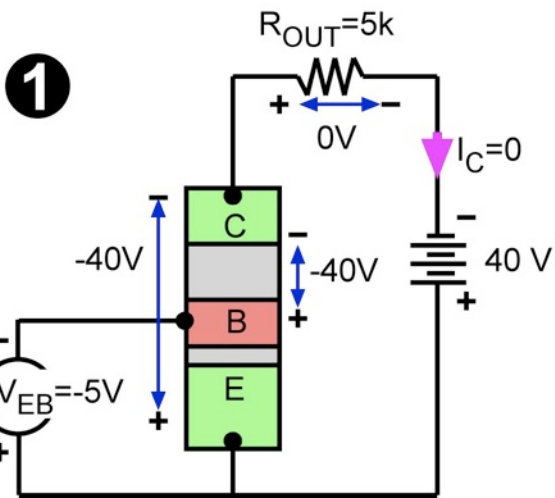
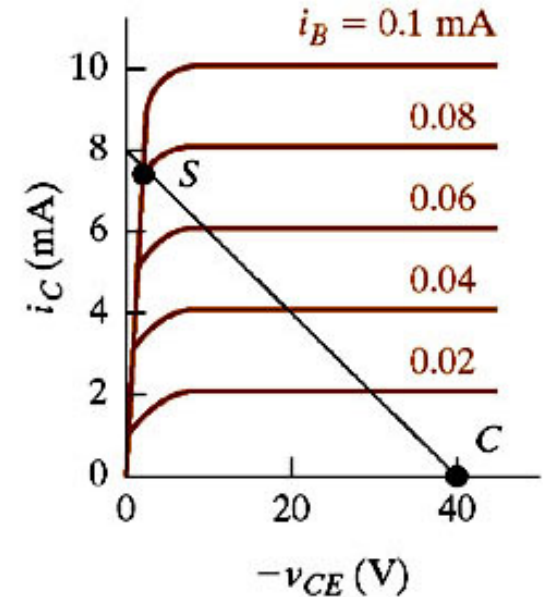
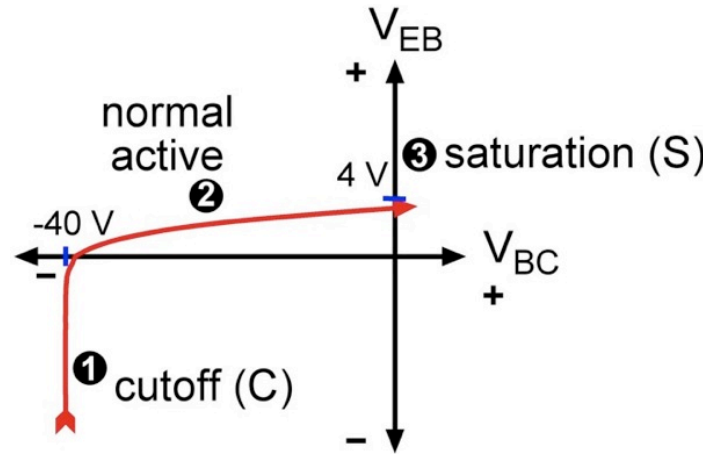
- as a logic switch between (1) and (3) ... *not so popular!*
- as an amplifier (2) ... *used in many applications*

... BJT's are attractive because so linear and you are only limited to  $R_{OUT}$  which can be small

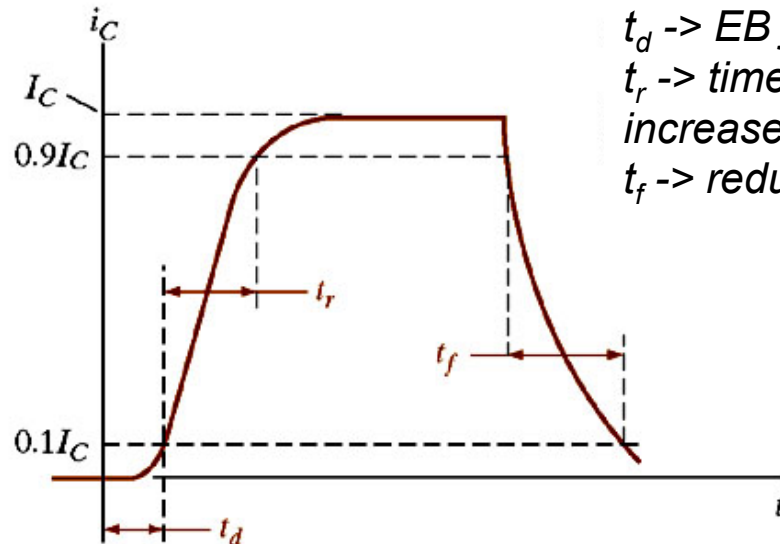


▶ Remember, we always have an  $R_{out}$  for every type of device in this course...

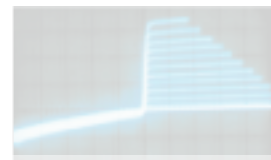
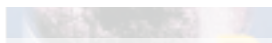
... in this case it is the lightly-doped (resistive) collector. The collector is lightly doped because of how we fabricate the device (more info later...).



- ▶ Remaining sections in 7.6 (Cutoff/Saturation/Switching Cycle/Specifications) present further detail on BJTs as switches...
- ▶ We will skip these sections (since BJTs are mainly used as amplifiers these days)
- ▶ However, if you read-through them it will only enhance your understanding of BJTs (and BJT switches are still used)
- ▶ Basically, one thing that is shown in the remainder of 7.6 is that switching time for the BJT is derived and related to the same effects we derived for the PN junction switching time









$t_d$  -> EB junction cap (rev. to forward)  
 $t_r$  -> time for excess hole conc. in base to increase to saturation level  
 $t_f$  -> reduction of hole conc. in base

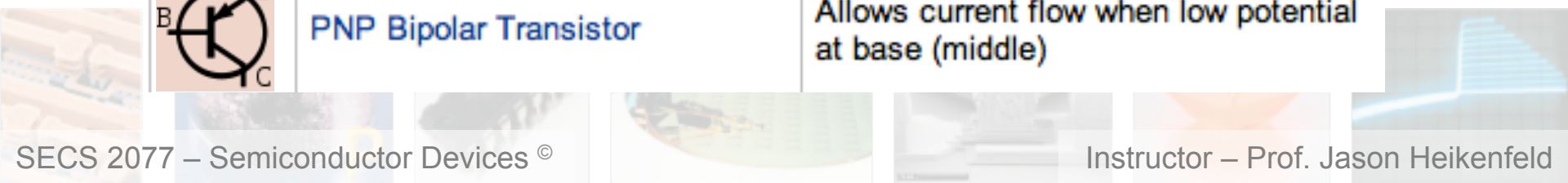


► How to tell different transistors apart... (but you will find not everyone follows this!).

Look at diagrams... Why 'B' and 'C' lines connect so close to one another at 'B'? *Two reasons, one could be due to the fabrication method for the point-contact transistor...*

Why E current direction different for PNP vs NPN? *Think of just the PN part of each device...*

	JFET-N Transistor	N-channel field effect transistor
	JFET-P Transistor	P-channel field effect transistor
	NMOS Transistor	N-channel MOSFET transistor
	PMOS Transistor	P-channel MOSFET transistor
	NPN Bipolar Transistor	Allows current flow when high potential at base (middle)
	PNP Bipolar Transistor	Allows current flow when low potential at base (middle)



▶ To make a BJT we have to take two back-to-back PN junctions but make two key modifications.... Small or wide base width? Heavy or light base doping? ★

▶ These two modifications increase amplification, and ... increase base current or decrease required base current? ★

▶ Assume an amplification factor of 100. I use the base wire to add 4 electrons to the base, on average how many additional holes will be in the base at any given time? Zero, four, or four-hundred holes? ★

▶ Lets say I cut the base terminal wire and using my 'electron gun' I again add 4 electrons to the base, and assume my amplification factor is 100. How many holes will I collect? Zero, four, or four-hundred holes? ★

▶ Bit tougher question, how many holes did I emit from the emitter? Here is your hint... you will need the holes collected, plus enough holes to eventually cause the electrons to recombine... Zero, four, four-hundred, or four-hundred and four? ★

▶ If I keep increasing  $I_B$ ,  $I_C$  will... Not change, keep increasing forever, or saturate as all voltage drop appears across  $R_{out}$  (the output resistance)? ★

